Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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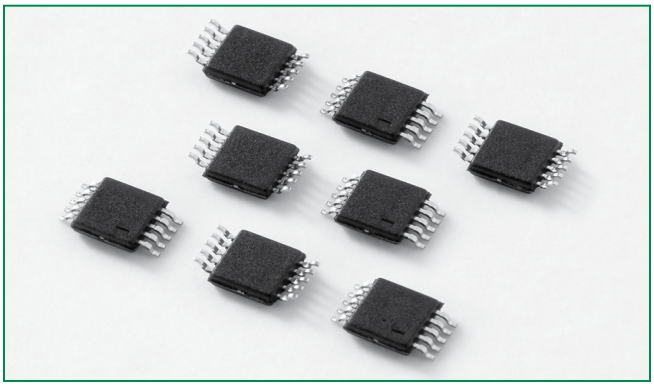
SP4065 Series 3.3V 20A Diode Array

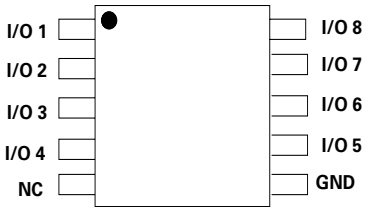
AUTOMOTIVE GRADE | HF | RoHS | Pb | GREEN



Description

The SP4065 integrates low capacitance diodes with an additional zener diode to protect each I/O pin against ESD and high surge events. This robust device can safely absorb up to 20A per IEC 61000-4-5, 2nd Edition (tp=8/20µs) without performance degradation and a minimum ±30kV ESD per IEC 61000-4-2 International Standard. Their low loading capacitance also makes them ideal for protecting highspeed signal pins.

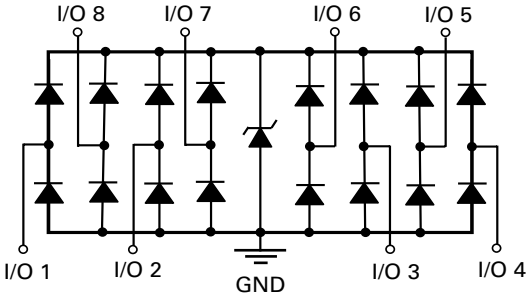
Pinout



Features

- ESD, IEC 61000-4-2, ±30kV contact, ±30kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, IEC 61000-4-5, 2nd Edition 20A (8/20µs)
- Low capacitance of 4.4pF (TYP) per I/O
- Low leakage current of 1µA (MAX) at 3.3V
- AEC-Q101 qualified
- Halogen free, Lead-free and RoHS compliant
- Moisture Sensitivity Level (MSL - Level 1)

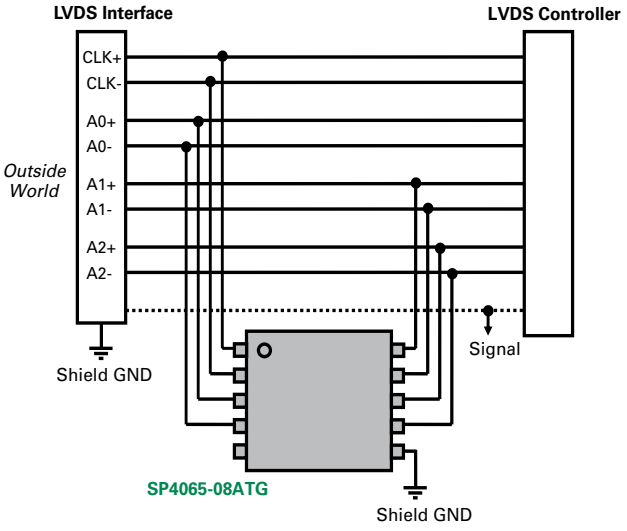
Functional Block Diagram



Applications

- LCD/LED TVs
- Desktops
- Game Consoles
- Set Top Boxes
- Notebooks
- 1Gb Ethernet
- Network Hardware
- Small Cells

Application Example



Additional Information

Datasheet | Resources | Samples

Life Support Note:
Not Intended for Use in Life Support or Life Saving Applications
The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

Revised: 12/29/16

TVS Diode Arrays (SPA® Diodes)

Lightning Surge Protection - SP4065

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
I_{PP}	Peak Current (t_p=8/20µs)	20.0	A
P_{PK}	Peak Pulse Power (t_p=8/20µs)	300	W
T_{OP}	Operating Temperature	-40 to 125	ºC
T_{STOR}	Storage Temperature	-55 to 150	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Thermal Information

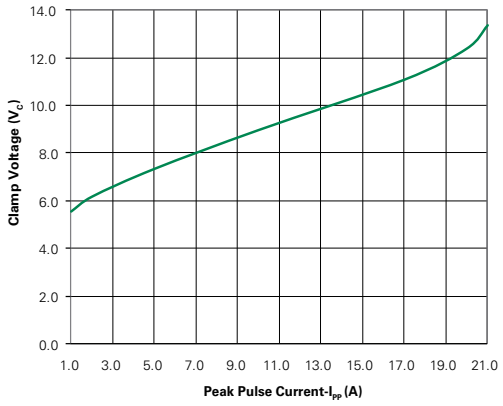
Parameter	Rating	Units
Storage Temperature Range	-55 to 150	°C
Maximum Junction Temperature	150	°C
Maximum Lead Temperature (Soldering 20-40s)	260	°C

Electrical Characteristics (T_{OP}=25°C)

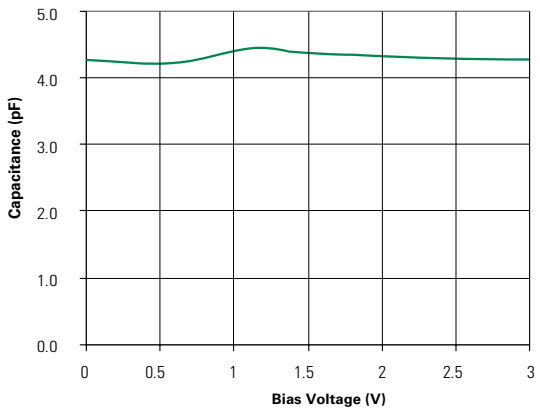
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Standoff Voltage	V_{RWM}				3.3	V
Snap Back Voltage	V_{SB}	I_{SB}=50mA	2.8			V
Reverse Leakage Current	I_{LEAK}	V_R=3.3V, I/O to GND		0.5	1.0	µA
Clamp Voltage[1]	V_C	I_{PP}=1A, t_p=8/20µs, Fwd		5.5		V
		I_{PP}=5A, t_p=8/20µs, Fwd		7.0		V
		I_{PP}=10A, t_p=8/20µs, Fwd		9.0		V
		I_{PP}=20A, t_p=8/20µs, Fwd		13.5		V
Dynamic Resistance	R_{DYN}	$(V_{C2} - V_{C1}) / (I_{PP2} - I_{PP1})$		0.4		Ω
ESD Withstand Voltage[1]	V_{ESD}	IEC61000-4-2 (Contact)	±30			kV
		IEC61000-4-2 (Air)	±30			kV
Diode Capacitance[1]	$C_{I/O-GND}$	Reverse Bias=0V		4.4	5.0	pF
Diode Capacitance[1]	$C_{I/O-I/O}$	Reverse Bias=0V		2.2		pF

Note: [1] Parameter is guaranteed by design and/or device characterization.

Clamping Voltage vs. I_{PP}



Capacitance vs. Bias

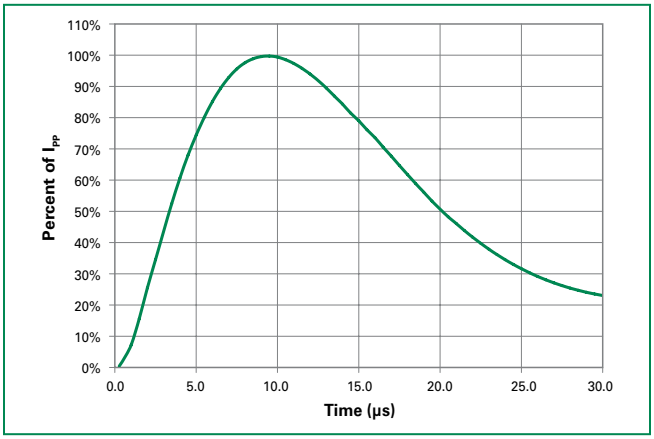


Revised: 12/29/16

TVS Diode Arrays (SPA® Diodes)

Lightning Surge Protection - SP4065

8/20µs Pulse Waveform



Product Characteristics

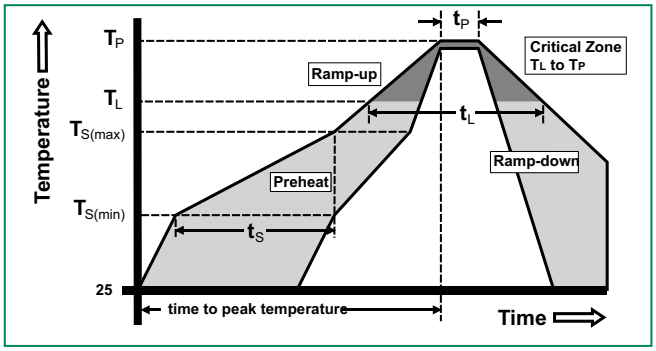
Lead Plating	Pre-Plated Frame
Lead Material	Copper Alloy
Lead Coplanarity	0.0004 inches (0.102mm)
Substrate material	Silicon
Body Material	Molded Epoxy, rated UL 94 V-0

Notes :

1. All dimensions are in millimeters
2. Dimensions include solder plating.
3. Dimensions are exclusive of mold flash & metal burr.
4. Blo is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
5. Package surface matte finish VDI 11-13.

Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus) Temp (T_L) to peak		3°C/second max
$T_{S(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_P)		$260^{+0/-5}$ °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_P)		8 minutes Max.
Do not exceed		260°C



Part Numbering System

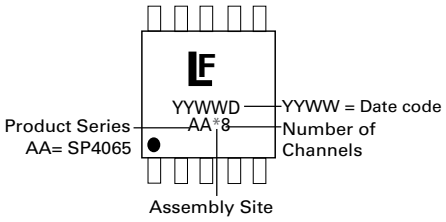
SP 4065 - 08 A T G

- SP 4065: TVS Diode Arrays (SPA® Diodes)
- 08: Number of Channels
- A: Package A = MSOP10
- T: T= Tape & Reel
- G: G= Green
- Series

Ordering Information

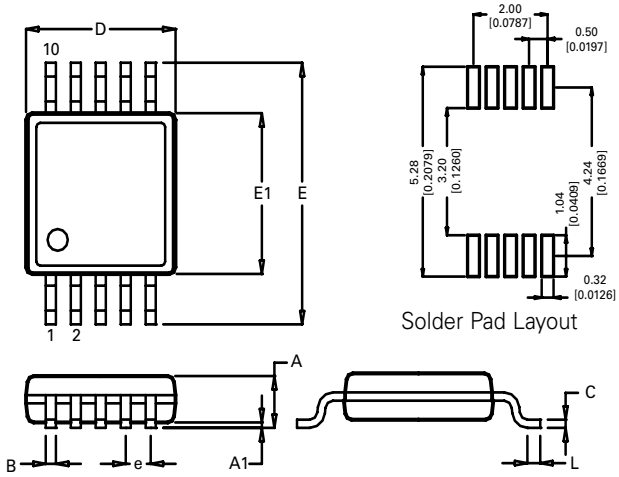
Part Number	Package	Marking	Min. Order Qty.
SP4065-08ATG	MSOP-10	AAH8	4000

Part Marking System



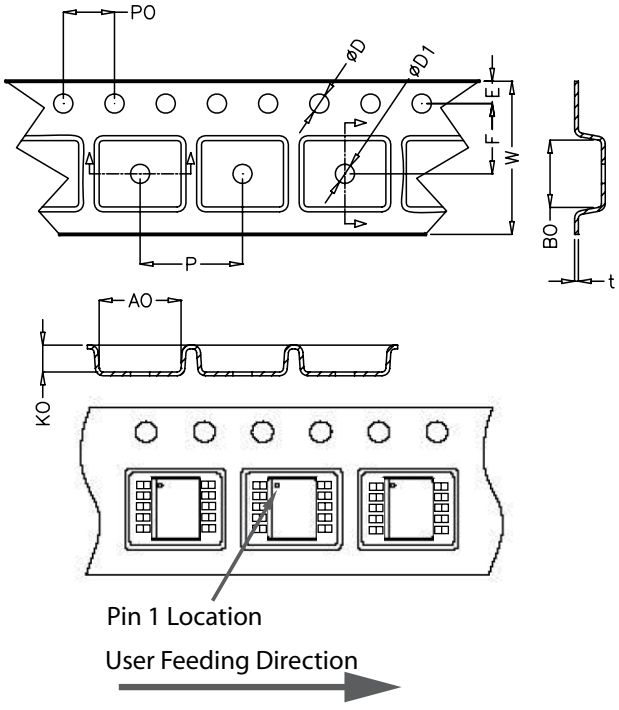
Revised: 12/29/16

Package Dimensions — MSOP-10



Package	MSOP			
Pins	10			
JEDEC	MO-187			
	Millimeters		Inches	
DIM	Min	Max	Min	Max
A	-	1.10	-	0.043
A1	0.00	0.15	0.000	0.006
B	0.17	0.27	0.007	0.011
c	0.08	0.23	0.003	0.009
D	2.90	3.10	0.114	0.122
E	4.67	5.10	0.184	0.200
E1	2.90	3.10	0.114	0.122
e	0.50 BSC		0.020 BSC	
L	0.40	0.80	0.016	0.032

Embossed Carrier Tape & Reel Specification — MSOP-10



	Millimetres		Inches	
	Min	Max	Min	Max
E	1.65	1.85	0.065	0.073
e	0.5		0.02	
F	5.40	5.60	0.213	0.220
D	1.50	1.60	0.059	0.063
D1	1.50 Min		0.059 Min	
P0	3.90	4.10	0.154	0.161
W	11.70	12.30	0.460	0.484
P	7.90	8.10	0.311	0.319
A0	5.20	5.40	0.205	0.213
B0	3.20	3.50	0.126	0.138
K0	1.20	1.50	0.047	0.059
t	0.30 +/- 0.05		0.012+/- 0.002	

Revised: 12/29/16